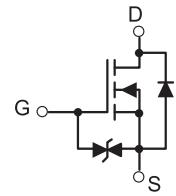




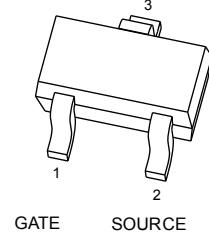
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## MT1012T N-Channel Power MOSFET

<b>V<sub>(BR)DSS</sub></b>	<b>R<sub>DS(on)MAX</sub></b>	<b>I<sub>D</sub></b>
20V	700mΩ@4.5V	500mA
	850mΩ@2.5V	



DRAIN



## SOT-523

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

Marking : C

## Maximum ratings ( $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source voltage	V <sub>DSS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±10	
Drain Current-Continuous	I <sub>D(DC)</sub>	500	mA
Drain Current -Pulsed(note1)	I <sub>DM(pulse)</sub>	1000	
Power Dissipation (note 2 , $T_a=25^\circ\text{C}$ )	P <sub>D</sub>	150	mW
Maximum Power Dissipation (note 3 , $T_c=25^\circ\text{C}$ )		275	
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub>	833	°C/W
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	455	
Storage Temperature	T <sub>j</sub>	150	°C
Junction Temperature	T <sub>stg</sub>	-55 ~ +150	



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$T_a=25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>On/Off States</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})DSS}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	20			V
Gate-Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.45	0.8	1.2	
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 4.5V$			$\pm 1$	$\mu\text{A}$
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 16V, V_{GS} = 0V$			100	nA
Drain-Source On-State Resistance	$R_{DS(\text{on})}$	$V_{GS} = 4.5V, I_D = 600\text{mA}$		250	700	$\text{m}\Omega$
		$V_{GS} = 2.5V, I_D = 500\text{mA}$		330	850	
Forward Transconductance	$g_{FS}$	$V_{DS} = 10V, I_D = 400\text{mA}$		1		S
<b>Dynamic Characteristics</b>						
Input Capacitance (note 4)	$C_{iss}$	$V_{DS} = 16V, V_{GS} = 0V, f = 1\text{MHz}$		100		pF
Output Capacitance (note 4)	$C_{oss}$			16		
Reverse Transfer Capacitance (note 4)	$C_{rss}$			12		
Total Gate Charge	$Q_g$	$V_{DS} = 10V, V_{GS} = 4.5V, I_D = 250\text{mA}$		750		nC
Gate-Source Charge	$Q_{gs}$			75		
Gate-Drain Charge	$Q_{gd}$			225		
<b>Switching Times (note 4)</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 10V, R_L = 47\Omega, I_D = 200\text{mA}, V_{GS} = 4.5V, R_G = 10\Omega$		5		nS
Rise Time	$t_r$			5		
Turn-Off Delay Time	$t_{d(off)}$			25		
Fall Time	$t_f$			11		
<b>Drain-Source Diode Characteristics</b>						
Drain-Source Diode Forward Voltage (note 5)	$V_{SD}$	$I_S = 0.15\text{A}, V_{GS} = 0V$			1.2	V

**Notes:**

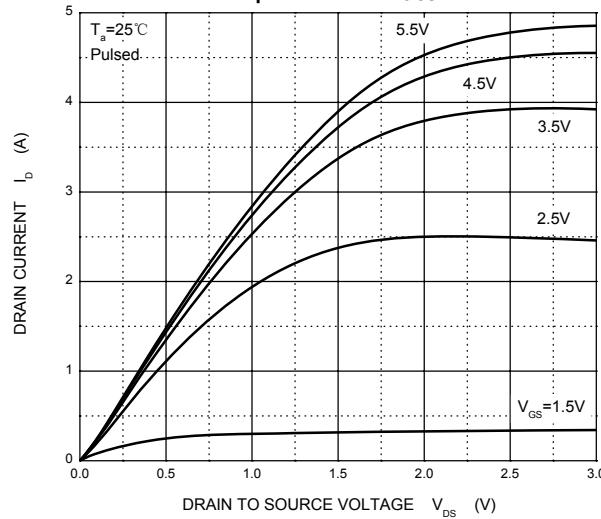
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at  $T_a=25^\circ\text{C}$ .
3. This test is performed with infinite heat sink at  $T_c=25^\circ\text{C}$ .
4. These parameters have no way to verify.
5. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .



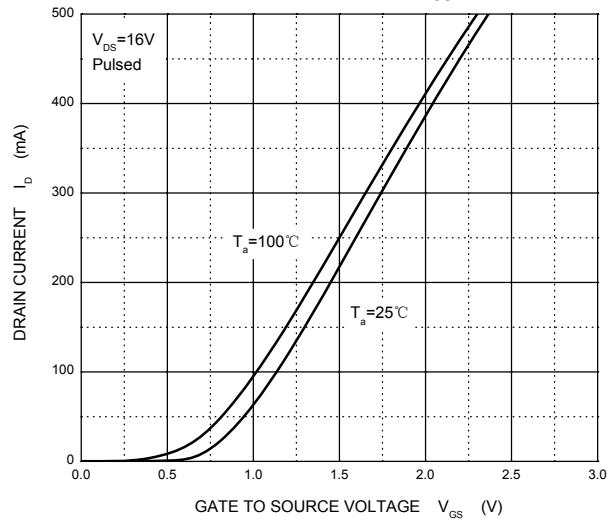
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## Typical Characteristics

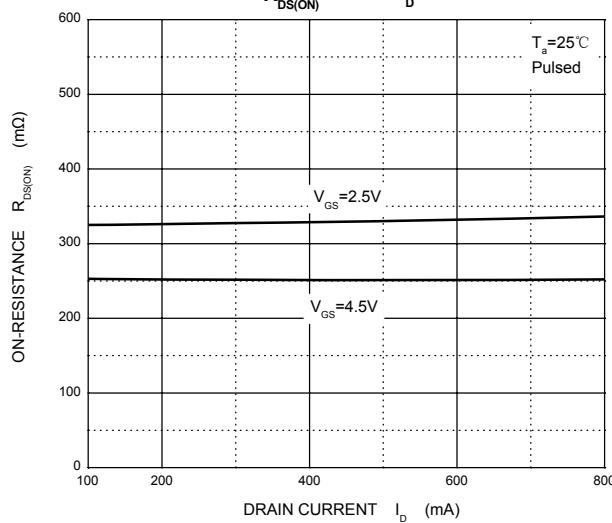
Output Characteristics



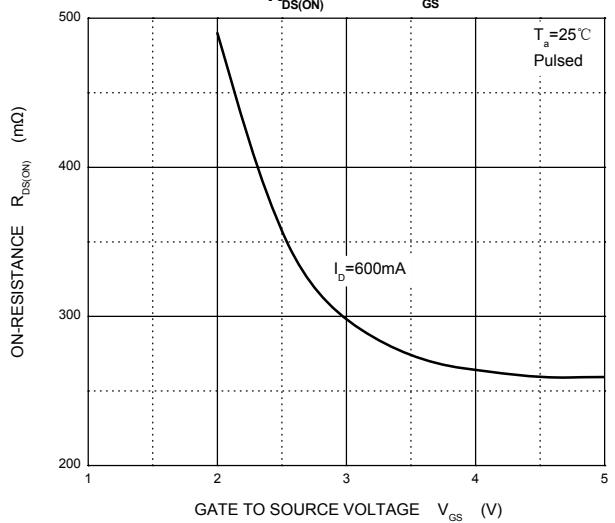
Transfer Characteristics



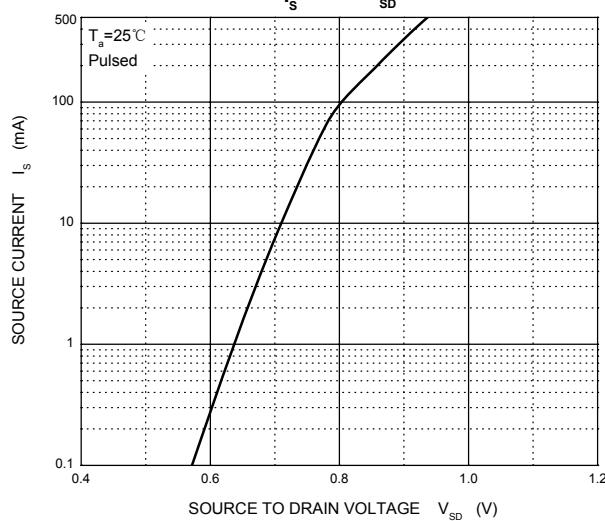
$R_{DS(ON)}$  —  $I_D$



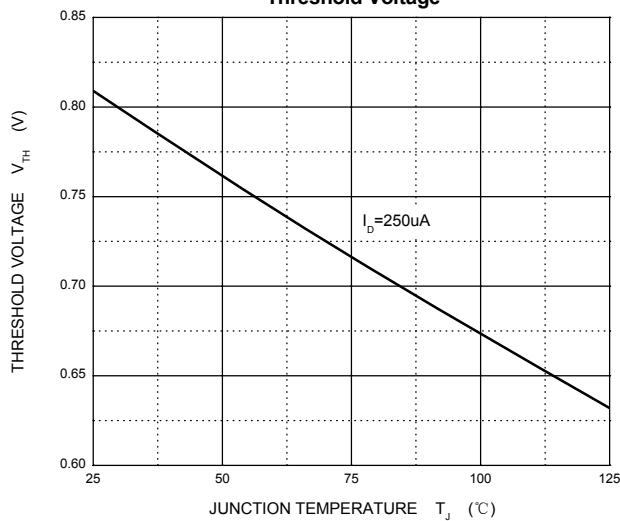
$R_{DS(ON)}$  —  $V_{GS}$



$I_S$  —  $V_{SD}$



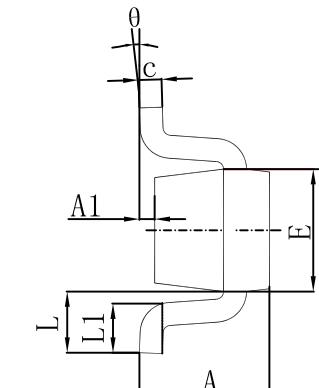
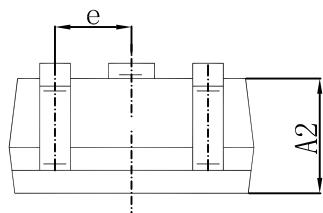
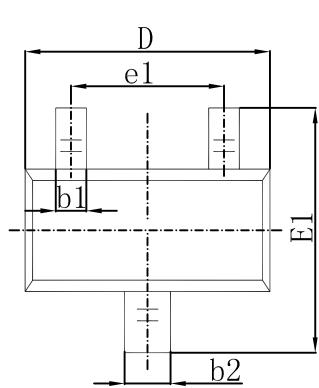
Threshold Voltage





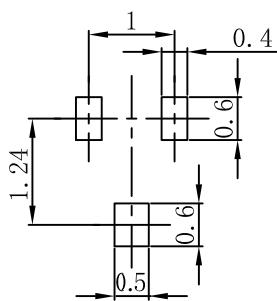
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### SOT-523 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

### SOT-523 Suggested Pad Layout



#### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$ .
3. The pad layout is for reference purposes only.